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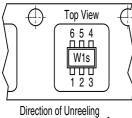
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### NPN/PNP Silicon Digital Transistor Array

- Switching circuit, inverter, interface circuit, driver circuit
- Two (galvanic) internal isolated NPN/PNP Transistors in one package
- Built in bias resistor ( $R_1=22k\Omega$ ,  $R_2=22k\Omega$ )

## Tape loading orientation

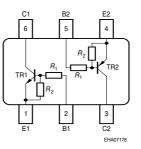


corresponds to pin 1 of device

(for example W1s)

Position in tape: pin 1 opposite of feed hole side EHA07193

Marking on SOT-363 package



Туре	Marking	Pin Configuration				Package		
BCR22PN	WPs	1=E1	2=B1	3=C2	4=E2	5=B2	6=C1	SOT363

### Maximum Ratings

Parameter	Symbol	Value	Unit	
Collector-emitter voltage	V <sub>CEO</sub>	50	V	
Collector-base voltage	V <sub>CBO</sub>	50		
Emitter-base voltage	V <sub>EBO</sub>	10		
Input on Voltage	V <sub>i(on)</sub>	30		
DC collector current	I <sub>C</sub>	100	mA	
Total power dissipation, $T_{\rm S}$ = 115 °C	P <sub>tot</sub>	250	mW	
Junction temperature	Tj	150	°C	
Storage temperature	T <sub>stg</sub>	-65 150		

### **Thermal Resistance**

Junction - soldering point <sup>1)</sup>	R <sub>thJS</sub>	≤ <b>140</b>	K/W
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<sup>1</sup>For calculation of  $R_{\text{thJA}}$  please refer to Application Note Thermal Resistance



Parameter	Symbol	Values			Unit	
		min.	typ.	max.	1	
DC Characteristics			•		•	
Collector-emitter breakdown voltage	V <sub>(BR)CEO</sub>	50	-	-	V	
$I_{\rm C} = 100 \ \mu {\rm A}, \ I_{\rm B} = 0$						
Collector-base breakdown voltage	V <sub>(BR)CBO</sub>	50	-	-		
$I_{\rm C} = 10 \ \mu {\rm A}, \ I_{\rm E} = 0$						
Collector cutoff current	I <sub>CBO</sub>	-	-	100	nA	
$V_{\rm CB} = 40  \text{V},  I_{\rm E} = 0$						
Emitter cutoff current	I <sub>EBO</sub>	-	-	350	μA	
$V_{\rm EB} = 10  \rm V, \ I_{\rm C} = 0$						
DC current gain 1)	h <sub>FE</sub>	50	-	-	-	
<i>I</i> <sub>C</sub> = 5 mA, <i>V</i> <sub>CE</sub> = 5 V						
Collector-emitter saturation voltage1)	V <sub>CEsat</sub>	-	-	0.3	V	
<i>I</i> <sub>C</sub> = 10 mA, <i>I</i> <sub>B</sub> = 0.5 mA						
Input off voltage	V <sub>i(off)</sub>	0.8	-	1.5		
<i>I</i> <sub>C</sub> = 100 μA, <i>V</i> <sub>CE</sub> = 5 V						
Input on Voltage	V <sub>i(on)</sub>	1	-	2.5		
$I_{\rm C}$ = 2 mA, $V_{\rm CE}$ = 0.3 V						
Input resistor	R <sub>1</sub>	15	22	29	kΩ	
Resistor ratio	$R_{1}/R_{2}$	0.9	1	1.1	-	
AC Characteristics						
Transition frequency	f <sub>+</sub>	_	130	_	MH <sub>2</sub>	

### **Electrical Characteristics** at $T_A$ =25°C, unless otherwise specified

Transition frequency	f <sub>T</sub>	-	130	-	MHz
<i>I</i> <sub>C</sub> = 10 mA, <i>V</i> <sub>CE</sub> = 5 V, <i>f</i> = 100 MHz					
Collector-base capacitance	C <sub>cb</sub>	-	3	-	pF
V <sub>CB</sub> = 10 V, <i>f</i> = 1 MHz					

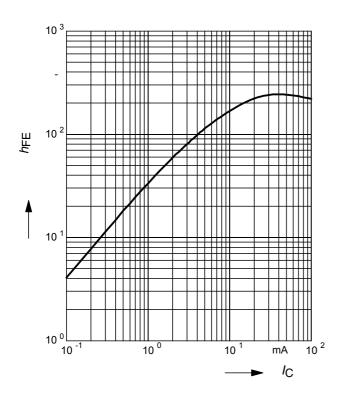




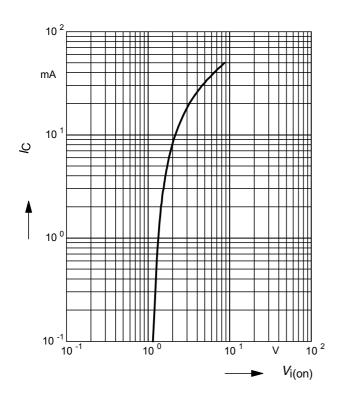
## **NPN** Type

# **DC Current Gain** $h_{\text{FE}} = f(l_{\text{C}})$

 $V_{CE} = 5V$  (common emitter configuration)

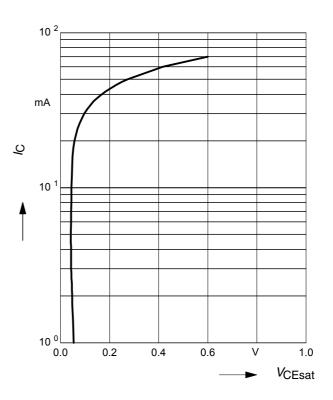


Input on Voltage  $V_{i(on)} = f(I_C)$  $V_{CE} = 0.3V$  (common emitter configuration)

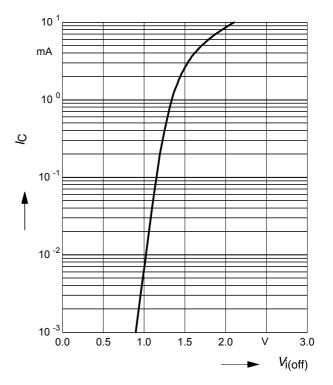


## **Collector-Emitter Saturation Voltage**

 $V_{\text{CEsat}} = f(I_{\text{C}}), h_{\text{FE}} = 20$ 



**Input off voltage**  $V_{i(off)} = f(I_C)$  $V_{CE} = 5V$  (common emitter configuration)



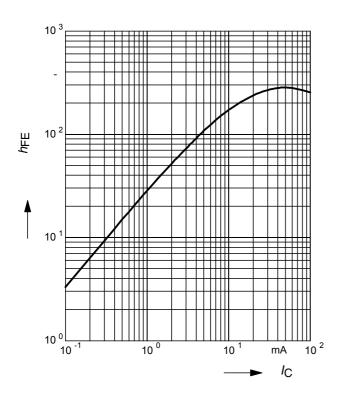




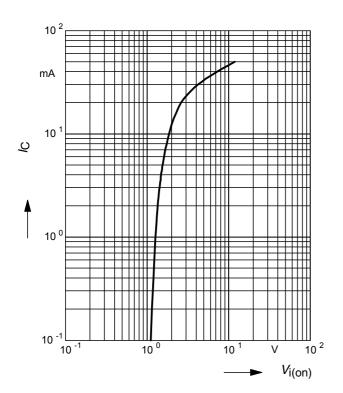
# **PNP** Type

# **DC Current Gain** $h_{\text{FE}} = f(I_{\text{C}})$

 $V_{CE} = 5V$  (common emitter configuration)

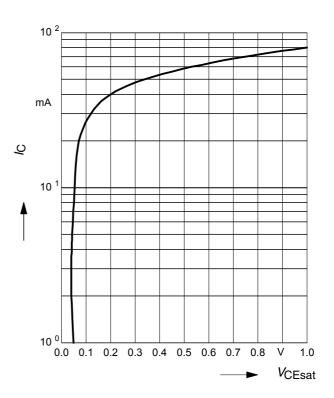


# Input on Voltage $V_{i(on)} = f(I_C)$ $V_{CE} = 0.3V$ (common emitter configuration)

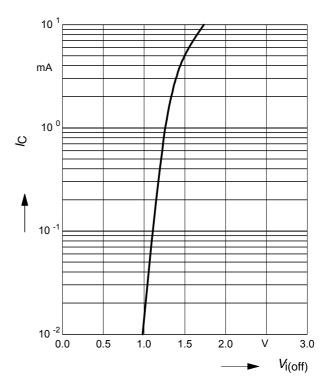


## **Collector-Emitter Saturation Voltage**

 $V_{\text{CEsat}} = f(I_{\text{C}}), h_{\text{FE}} = 20$ 



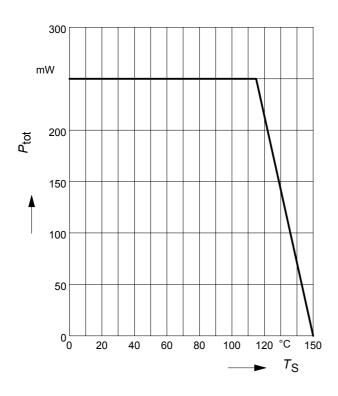
# Input off voltage $V_{i(off)} = f(I_C)$ $V_{CE} = 5V$ (common emitter configuration)







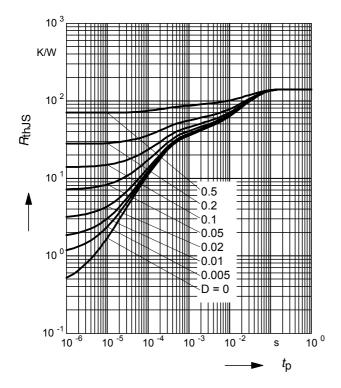
# Total power dissipation $P_{\text{tot}} = f(T_{\text{S}})$

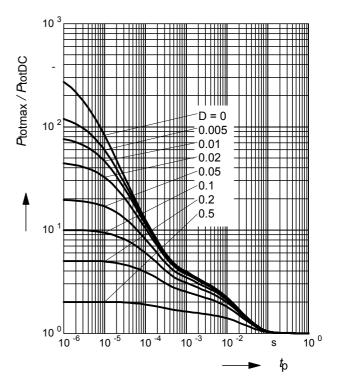


Permissible Pulse Load  $R_{thJS} = f(t_p)$ 

Permissible Pulse Load

 $P_{\text{totmax}} / P_{\text{totDC}} = f(t_{\text{p}})$ 





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